



The 5th IEEE International Conference on Consumer Electronics – Berlin, 6 – 9 September 2015



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CALL FOR PAPERS

The 5th IEEE International Conference on Consumer Electronics – Berlin (“ICCE-Berlin”) will be held from the 6th to 9th September 2015 in Berlin in parallel with the IFA, the leading trade show for Consumer Electronics and Home Appliances. The ICCE-Berlin is the European sister conference of the IEEE Consumer Electronics Society’s flagship conference “ICCE” held annually in Las Vegas in conjunction with the Consumer Electronics Show. Now in its 5th edition, ICCE-Berlin is well established and fully integrated in the IFA and continuously growing. This year the IEEE CE Society is joining forces with other IEEE societies to broaden and strengthen the CE subjects and scope of the conference: the Product Safety Engineering Society, the Reliability Society, the Vehicular Technology Society, the Community for Cloud Computing, the Life Sciences Technical Community, the Society of Social Implications of Technology, and the EMC Society. To allow these new participants to join us, we have extended the paper submission deadline a last time.

Berlin, a birthplace of consumer electronics, is one of Europe’s most exciting cultural centres and a vibrant city. The conference will again bring together researchers and engineers from industry, research centres, and academia to exchange information and results of recent work on systems, circuits, technologies, processes, and applications. It will provide an excellent forum for the researchers, system developers, and service providers to share their ideas, designs and experiences in such a proper environment as the IFA.

IEEE 2015 ICCE-Berlin is asking you for submissions of technical papers for oral and poster presentations. Prospective authors are invited to submit a 2-page abstract in any of the technical areas below as well as in other areas related to consumer electronics. The final paper may extend up to 5 pages. All accepted and presented papers will be submitted to IEEE Xplore for publishing. Student papers are particularly encouraged. The conference especially covers the following subject areas – for topics in detail please visit our web site:

Audio and Video Technology

Entertainment and Games

Car Electronics

Consumer Networks

RF & Wireless

Human-Device Interaction

Sports, Wellness and Home Healthcare

Smart Energy

Product Safety Engineering



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Important Dates

Final Abstract Submission Deadline:
15 June 2015

Notification of Acceptance:
30 June 2015

Final Paper Submission Deadline:
31 July 2015

Paper Submission at the ICCE-Berlin website www.icce-berlin.org

Keynote Speakers

Tom Coughlin,
Coughlin Assoc., US
Jacob Fahrenkrug,
yetu, DE
Brian Markwalter,
CE Association, US
More coming soon

Tutorials

Karlheinz Brandenburg,
Fraun./TU Ilmenau, DE

Doctoral Workshop for PhD students and **Young Professionals Short Course:** see more at www.icce-berlin.org

IEEE 2015 ICCE-Berlin website: <http://www.icce-berlin.org>

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